

REVISION RECORD				
REV	ECD	DESCRIPTION	DRFT	CHKD

NOTES:

MATERIAL:

1. HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL :PHOSPHOR BRONZE t=0.35mm.
3. PLATING : GOLD PLATING 3u"~50u"OVER NICKEL

ELECTRICAL:

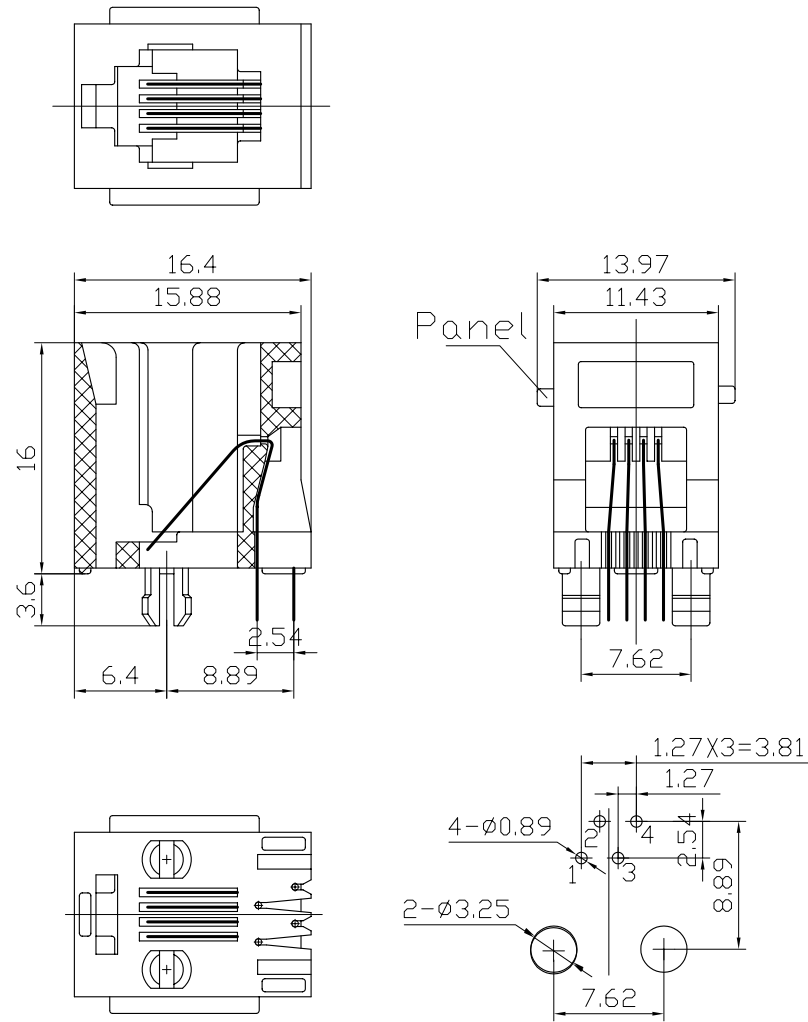
1. VOLTAGE RATING :125 VAC RMS.
2. CURRENT RATING :1.5 AMP.
3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

1. DURRABILITY: :750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40° C TO 85° C.
2. OPERATION : 0° C TO 70° C.



PC Board Layout
Component Side Shown

DETACHED LISTS	MM (INCH)		DFTO: SHB	DATE: 7.05.05	东莞市库乐信息科技有限公司	
	TOLERANCES EXCEPT AS NOTED		CHKD: LANBO	DATE: 2007.05.05		
	MM		MFO:	DATE:	TITLE	
	.0 ± 0.15		APPLV:	DATE:		
	.00 ± 0.075		MATERIAL :		52 TOP ENYRY JACK 4P4C	
ANGLES ± 0.5		QT'Y :		DRAWING NO. TE52A1003		SIZE
THIRD ANGLE PROJECTION		FINISH :		/PART NO.		REV
		SCALE :		DO NOT SCALE DRAWING		0
				SHEET		OF